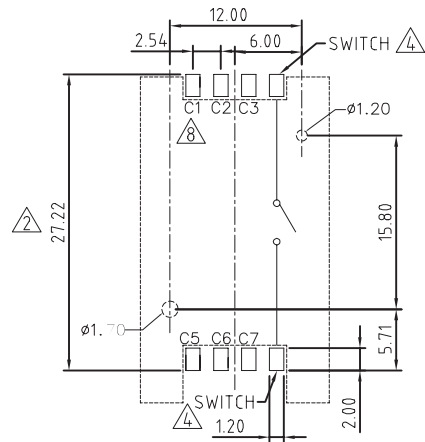
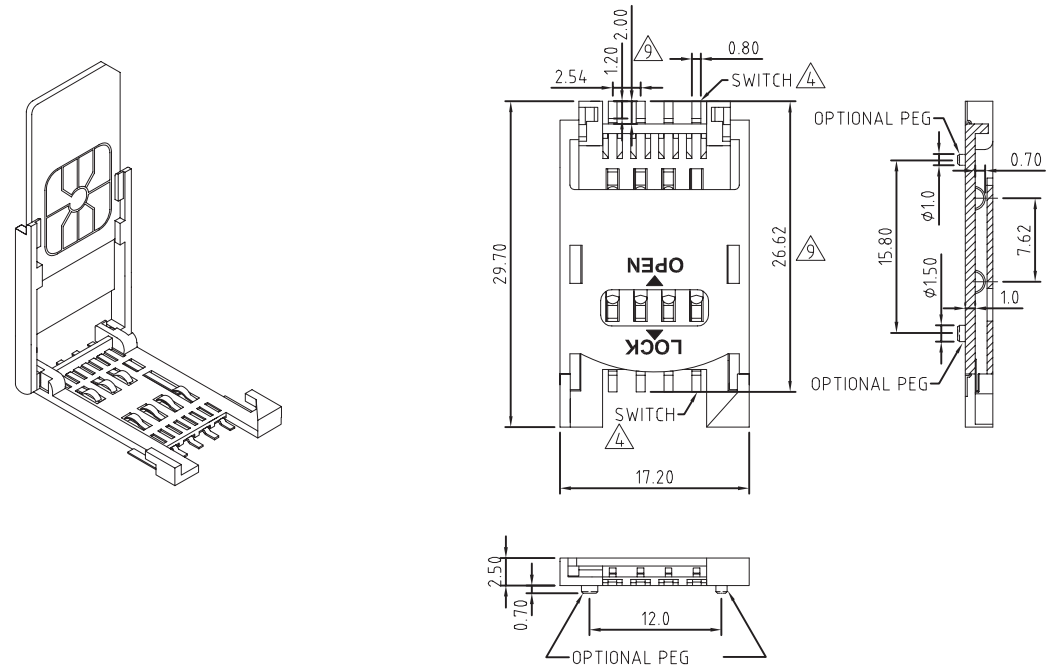


FEATURES

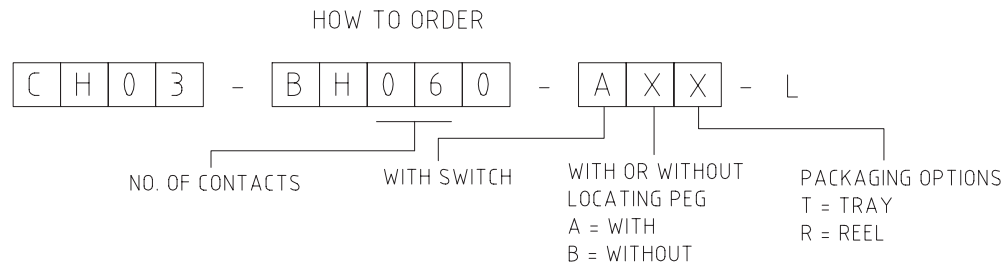
1. GENERAL CHARACTERISTICS
- DIMENSIONS: 29.70L x 17.20W x 2.50H mm
- OPERATING POSITION: SHAFT UP / DOWN / HORIZONTAL
- MOUNTING SYSTEM: SMT TYPE
- DURABILITY: 5,000 CYCLES
- OPERATION TEMPERATURE: -25°C TO +85°C
2. MECHANICAL CHARACTERISTICS
- INSULATION MATERIAL: THERMOPLASTIC, UL 94V-0
- CONTACT MATERIAL: PHOSPHOR BRONZE
- CONTACT PLATING: GOLD ON CONTACT AREA, TIN ON SOLDER TAIL
3. ELECTRICAL CHARACTERISTICS
- CONTACT RESISTANCE: 30M OHMS MAX.
- INSULATION RESISTANCE:> 1000M OHMS MIN. / 500V DC
- RATED CURRENT: 0.5A MAX.
- RATED VOLTAGE: 30V AC
- WITHSTANDING DIELECTRIC VOLTAGE: 500V AC R.M.S. FOR 1 MINUTE
4. SOLDERABILITY
- MAX. PROCESSING TEMP.: 260°C FOR 10 SEC.

NOTES:

1. ACCEPTABLE SIM CARD SIZE SHOULD MEET GSM 11.11 SPECIFICATION REQUIREMENT.



RECOMMENDED PCB LAYOUT



CH03-BH0X0-XXR-L - REEL PACKAGING DRAWING

SPECIFICATIONS

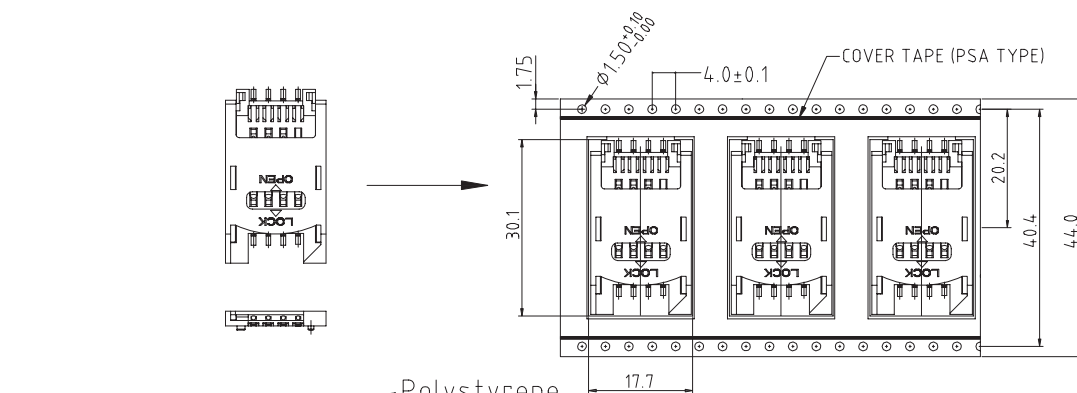
Reel Size: 330×44.5mm

PE Bag Size: 0.08×700×630mm

Carton Size: 346×346×330mm

QTY: 650Pcs/Reel

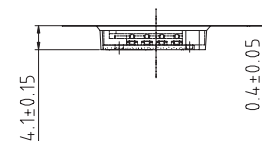
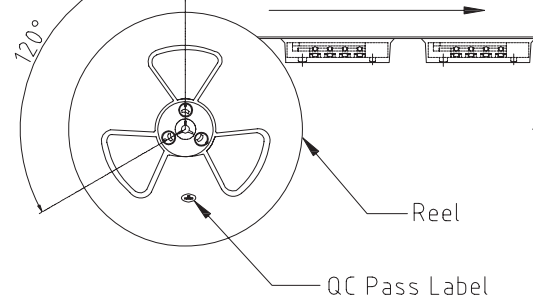
RoHS Compliant



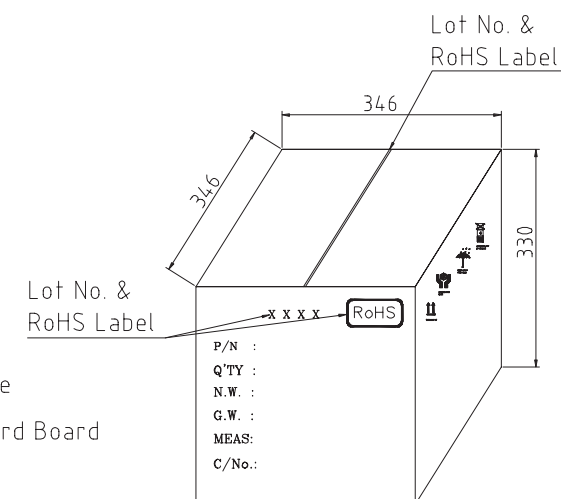
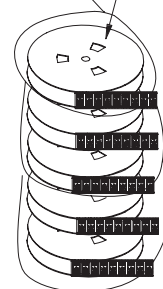
Packing Material Description

Polystyrene

Pull Out Direction



PE Bag Plastic Reel for Embossed Tape



Note:

- 1 REEL=650 PCS
- 1 BOX=6 REEL

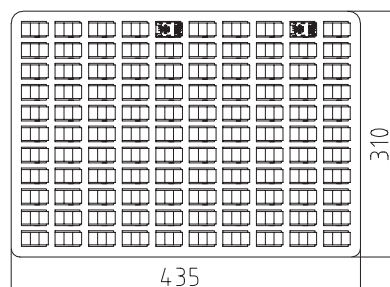
	THIRD ANGLE	Unstated .X .XX	Tolerances: ±0.20 ±0.10	Material SEE NOTE
Drawn: CHC		ANGLES	±1°	
App'd: XXX	Title: PACKAGING	NOT TO SCALE		
Date: 03 FEB '09	Revision: 1.0	Unit: mm		



CH03-BH0X0-XXT-L - TRAY PACKAGING DRAWING

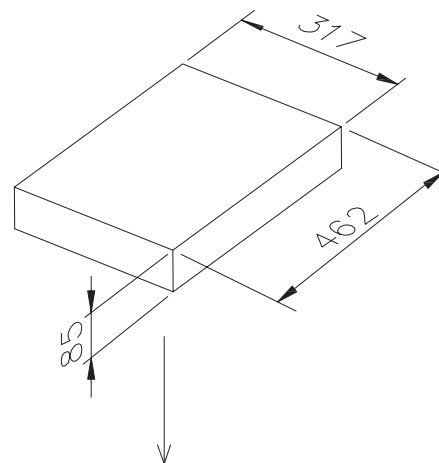
PACKING CONDITION

TRAY×10 (110PCS/TRAY)

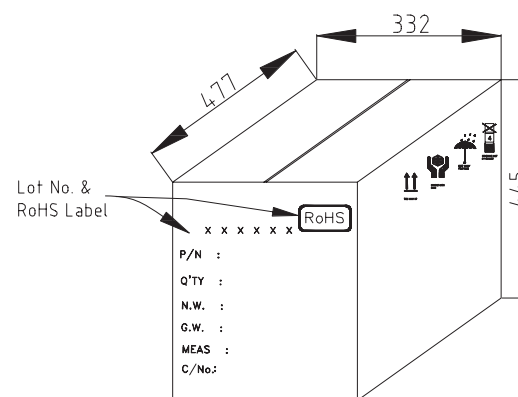


Q'TY/PCS		
OUTER BOX	INNER BOX	TRAY
5500	1100	110

INNER BOX×5 (1100PCS/BOX)



OUTER BOX×1 (5500PCS)



Drawn: CHC	THIRD ANGLE	Unstated .X .XX	Tolerances: ±0.20 ±0.10	Material SEE NOTE
	ANGLES ±1°			
App'd: XXX	Title: PACKAGING	NOT TO SCALE		
Date: 03 FEB '09	Revision: 1.0	Unit: mm		